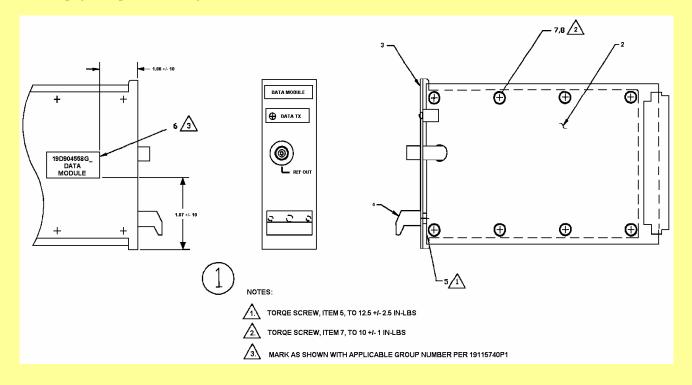
ADDENDUM NUMBER 1 TO MAINTENANCE MANUAL LBI-38918B Refer to ECO#20043005

GENERAL

This addendum documents a change to the Data Module (19D904558G1) Maintenance Manual. Torque specification changed from 20 in-lbs. to 12.5 ± 2.50 in-lbs.

CHANGES

On page 6, update drawing 19D904558 with revision 1.



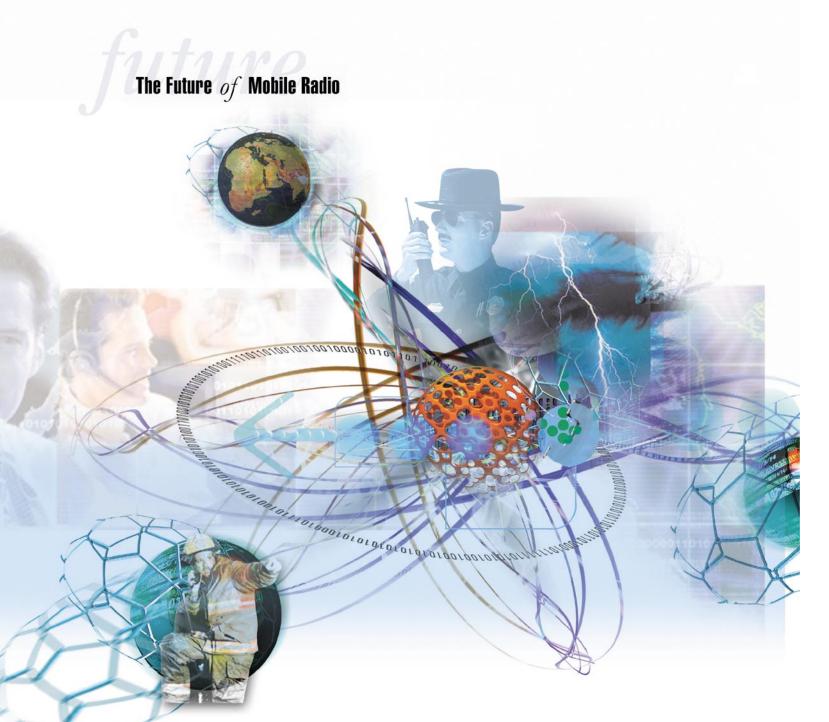
(19D904558, Rev. 1)





M/A-COM Wireless Systems 221 Jefferson Ridge Parkway Lynchburg, Virginia 24501 (Outside USA, 434-385-2400) Toll Free 800-528-7711 <u>www.macom-wireless.com</u> Maintenance Manual LBI-38918B





MASTR® III Data Module (Paging Adapter) 19D904558G1





M/A-COM Wireless Systems 3315 Old Forest Road Lynchburg, Virginia 24501 (Outside USA, 434-385-2400) Toll Free 800-528-7711 www.<u>macom-wireless.com</u>

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SPECIFICATIONS*

Input Voltage Range:	-25V to +25V max 0V to +5V min
Input Data Range:	0-9600 baud
Input Data Type:	2 level NRZ such as Golay, POCSAG, etc.
RF Frequency Stability:	Less than or equal to 2.0 ppm (-30°C to $+60$ °C)
RF Output Frequency:	12.800 MHz
RF Output Level:	$0 \text{ dBm} \pm \text{dB}$

* These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

DESCRIPTION

Data Module 19D904558G1 allows the MASTR III Base Station to transmit Non Return to Zero (NRZ) data such as those produced by paging systems. The Data Module accepts data with rates up to 9600 baud within a range of -25V to +25V. The output of the data adapter is a modulated 12.8 MHz reference signal and a filtered data that modulates the Transmit Synthesizer.

COMPATIBILITY

The Data Module (19D904558G1) is not compatible with EDACS, Voice Guard, Simulcast and Voting Receivers.

Firmware 344A3307G13 and above on the System Module and PC Programmer version 7.0 and above must be installed to use the Data Module.

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CIRCUIT ANALYSIS

The Data Module is designed to operate using the +5V, -5V, +12V, -12V and 13.8V supply voltages generated by the Power Module and applied through the backplane. The voltage regulator, U6 (LM317) and is associated components, maintain +10V for ICOM operation.

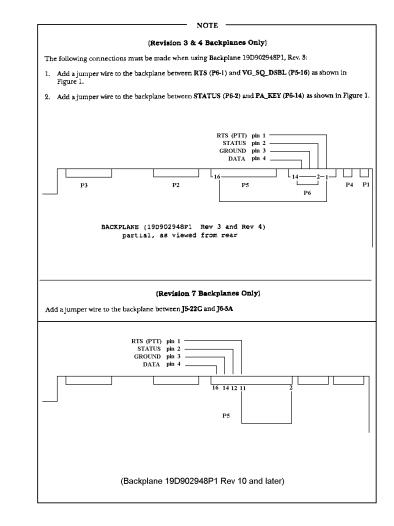
A block diagram of the Data Module is given in Figure 2. The Data Module is enabled by grounding **RTS** (on the backplane). The data signal is applied to **DATA** (of the backplane). The Data Module transforms the input data into TTL data using transistor Q1 configured as a common-emitter buffer and inverts the data where appropriate by selecting switch S1 as shown in Table 1. This prepares the data for the modulation process.

Once the data is conditioned by Q1, it is passed to a multiplexer circuit (U1), where U1 is used to select the output deviation level. When the data bit is positive, a voltage divider

consisting of resistors R9 and R11 and potentiometer R10 is used to control the negative deviation output. If the data bit is negative, a voltage divider consisting of resistors R6 and R8 and potentiometer R7 is used to control the positive deviation output. To set the positive and negative adjustments refer to the procedure outlined in the adjustments section.

The data is then filtered through two (U3.1, U3.2) or three active low-pass filters (U2.2, U3.1, U3.2) based upon the input data rate selected. For high speed data (1200-9600), S1 is selected, as shown in Table 1, to allow only two filters (U3.1 and U3.2) to be used. For data rates equal to or less than 1200 baud, S1 is configured as shown in Table 1, to use filters U2.2, U3.1 and U3.2. The frequency response of the filters is shown in Figure 3. When U3.1 and U3.2 filters are used the response rolls off at about 1 kHz. When all the filters are used the roll off does not occur until about 5.5 kHz.

After the data is filtered, the output is split into two signals. The first signal is filtered data. This data is amplified by U4.1 and the gain of the data is adjusted by R26. The data is then output on EXT HSD (J1.26B) of the data module



LBI-38918B

and used to modulate the Voltage Controlled Oscillator (VCO) of the transmit synthesizer. The second signal is used to modulate the 12.8 MHz reference ICOM (J2.3). The output of the ICOM (J2.2) is a 12.8 MHz modulated reference with a + 10 dBm output. The modulated output is fed to high input impedance buffer Q2 which drives the MMIC amplifier (U5) into compression, and the gain of the MMIC is about 14 dB. The low pass elliptical filter, consisting of L1 and C20-C22 filters the high frequency harmonics. The next stage is a resistive pad (R35-R37) that provides a constant input/output impedance (50 ohms) and protects the amplifier from externally induced impedance mismatches.

The final output is a 0 dBm, 12.8 MHz modulated reference signal that replaces the receive synthesizer reference normally used to drive the transmit synthesizer.

The above operations enable the Data Module to modulate the 12.8 MHz reference oscillator and allow the high and low frequency components of the input data to be transmitted when using the paging adapter on the MASTR III Base Station.

Figure 1 - MASTR III Backplane

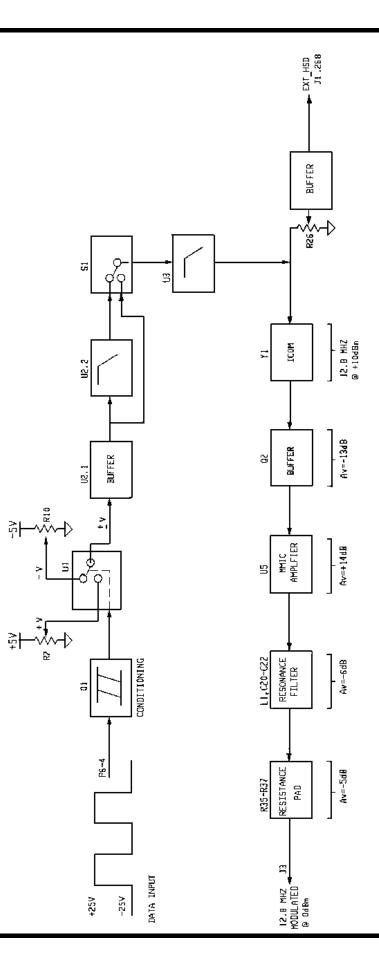


TABLE 1 - Switch S1 Configurations

S1.1	S1.2	S1.3	S1.4	S1.5	S1.6	
OFF	OFF	X	Х	Х	X	Transmit inverted data
OFF	ON	Х	Х	Х	Х	Transmit normal data
X	Х	OFF	ON	Х	Х	Three filters, below 1200 baud
X	X	ON	OFF	Х	X	Two filters, 1200- 9600 baud
ON	Х	Х	Х	Х	Х	Data select over- ride

X - don't care

INSTALLATION

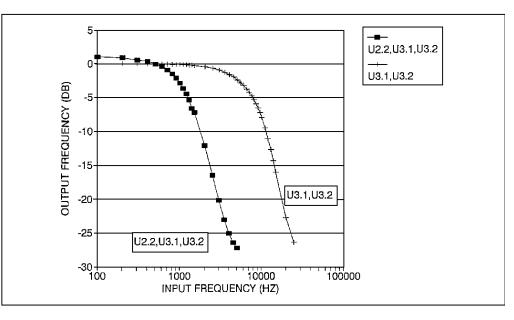
EQUIPMENT

2 - Data Module Block Diagram

Figure

The Data Module options package SXDE5B includes the following items:

- Data Adapter Module (19D904558G1)
- BNC-BNC Cable (344A4688P1)



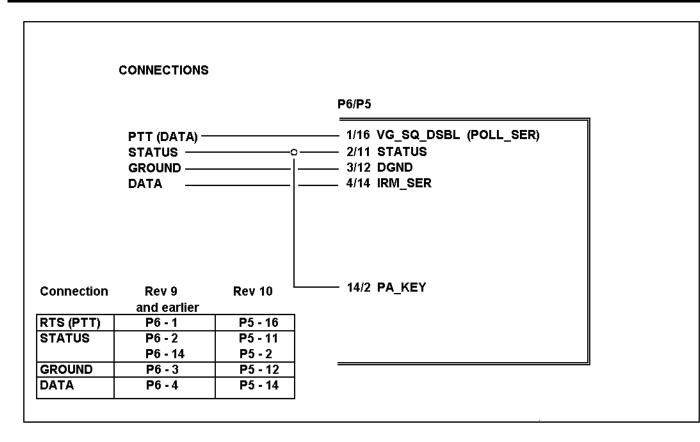
The following equipment is required to install the Data Module:

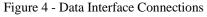
- Personal Computer (IBM PC compatible)
- PC Programmer versions 7.0 and above (TQ3353)
- Programming Cable (TQ3356)

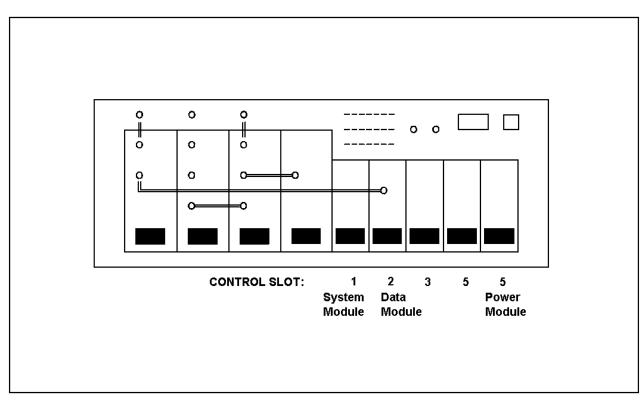
MODULE INSTALLATION

- 1. Connect the computer serial COM port and DATA **PORT** on the front of the T/R Shelf using TQ3356 Interconnect cable.
- 2. Enable the Digital Pager in the Control Shelf Options menu of the PC Programmer installed at the personal computer interfaced with the station.
- 3. Remove the blank panel from slot #2 of the control section of the station.
- 4. Remove the U-Link between the Transmit Synthesizer and the Receive Synthesizer. (**RF_IN** and **RF_OUT**)
- 5. Connect the BNC-BNC Cable (344A4688P1) between RF_IN of the Transmit Synthesizer and the Data Module as shown in Figure 5.
- 6. On the Transmit Synthesizer (19D902780), adjust VR601 for zero modulation.

NOTE-For stations with Backplane 19D902948P1, Rev. 3 see additions and Figure 1 in the Compatibility Section.







ALIGNMENT

Once the Data Module has been correctly installed, the positive and negative data deviation levels, the average deviation, and the station nominal frequency should be adjusted.

EOUIPMENT

- Calibrated Frequency Counter: 0.5 ppm measurements (800 MHz) 1.0 ppm measurements (UHF, VHF)
- Data Modulated Extender Card (19A903197G2)
- BNC-BNC Cable (344A4688P1)

DATA DEVIATION ADJUSTMENT

1. Make the following connections to the Backplane as shown in Figure 1:

RTS - Ground this pin to enable the external data to be routed to the transmitter instead of voice.

STATUS - Monitor this output. It should go HIGH (5 volts) when the transmitter is keyed and at full power output.

GROUND - Common ground connection for data and control.

DATA - Connect DATA to data output of paging unit.

- 2. Attach the Data Adapter Module (19D904558G1) to the Data Module Extender Card (19A903197G2) and insert in slot #2 of the control section of the station.
- 3. Connect the **RF_OUT** of the transmit synthesizer to the frequency counter to monitor the nominal carrier frequency.

Figure 5 - MASTR III Station

4. Select the filter type by setting S1 according to the data transmission requirements:

S1.1	S1.2	S1.3	S1.4	S1.15	S1.6	
XXX	XXX	ON	OFF	XXX	XXX	Data rates 1200-9600 baud
XXX	XXX	OFF	ON	XXX	XXX	Data rates up to 1200 baud

XXX - don't care

5. Select the data mode by setting S1 according to the data polarity requirements:

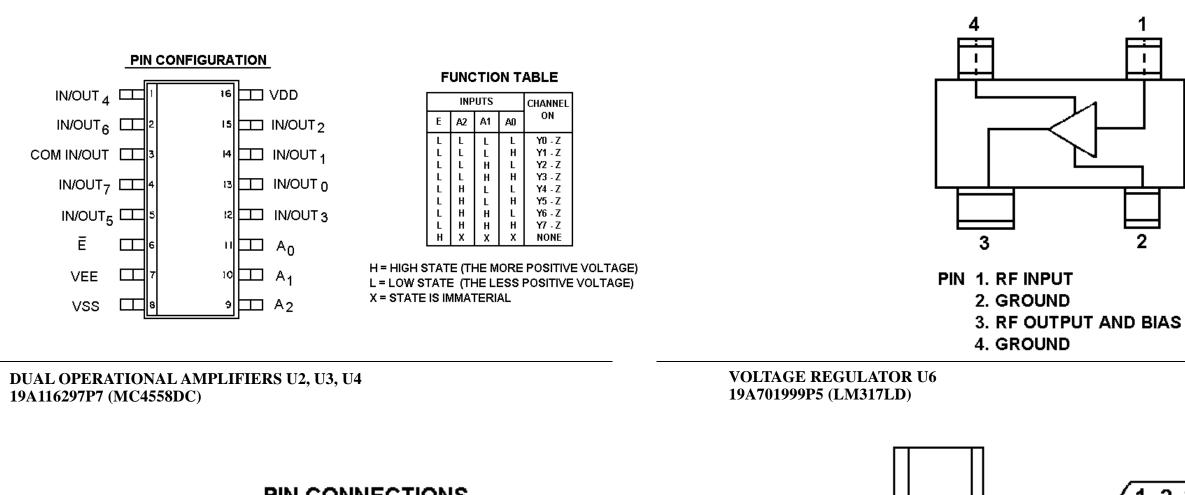
- XXX don't care

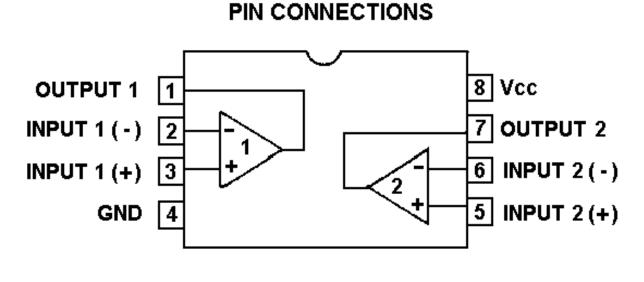
- **S1.1 S1.2 S1.3 S1.4 S1.5 S1.6** OFF OFF XXX XXX XXX XXX DAT INV, transmit inverted data OFF ON XXX XXX XXX XXX DAT NORM, transmit normal data
 - 6. Set the nominal carrier frequency by opening **RTS** and keying the transmitter with the **REM PTT** on the System Module. Adjust the ICOM frequency until the nominal carrier frequency is obtained on the frequency counter. Release the **REM PTT**.
 - 7. Set the negative frequency shift by grounding **RTS** and adjusting R10 until the nominal carrier frequency is minus 4.5 kHz.
 - 8. Set the positive frequency deviation by grounding DATA (or set S1 to DAT INV) and keying the data path by grounding RTS. Adjust R7 until the nominal carrier frequency is plus 4.5 kHz.
 - 9. Set the data deviation level by grounding RTS and applying a periodic data signal to DATA. Adjust R26 for a 4.5 kHz peak deviation.

IC DATA

ANALOG MULTIPLEXER U1 19A702705P3 (4051 BM)

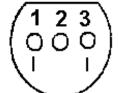
BIPOLAR OPERATIONAL AMPLIFIER U5 19A705927P1 (AVANTEK MSA-0611)





PIN 1. ADJUST PIN 2. OUTPUT PIN 3. INPUT

BOTTOM VIEW PIN IDENTIFICATION



PARTS LIST

MASTR III DATA MODULE 19D904558G1 Issue 1

DESCRIPTION

SYMBOL PART NUMBER

UNIVERSAL DATA ADAPTER 19D904549G1

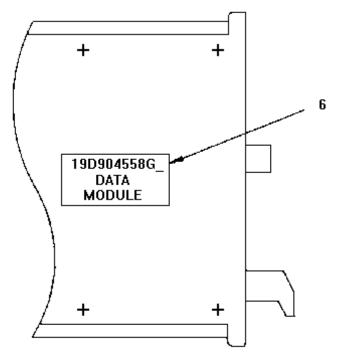
SYMBOL PART NUMBER

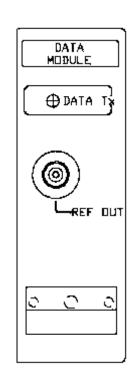
Issue 1

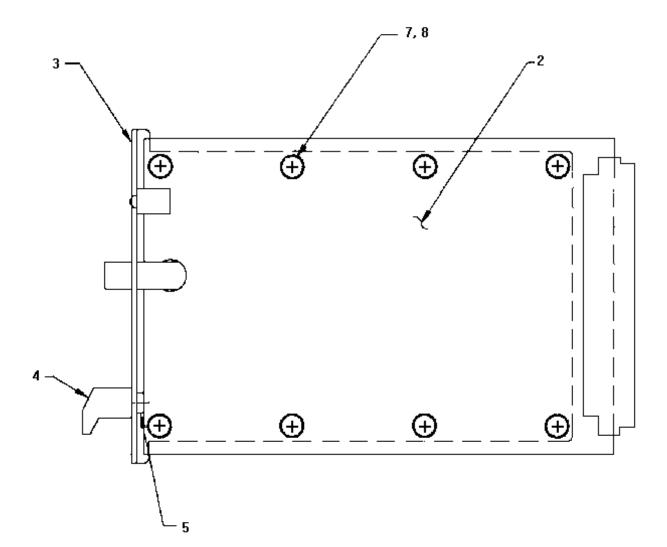
DESCRIPTION

					LBI-3891
	I			1	
MBOL	PART NUMBER	DESCRIPTION	SYMBOL	PART NUMBER	DESCRIPTION
C40 and C41	19A705205P2	Tantalum: 1 $\mu\text{F},$ 16 VDCW; sim to Sprague 293D.	R22 and R23	19B800607P103	Metal film: 10K ohms $\pm 5\%$, 1/8 w.
		DIODES	R24	19B800607P472	Metal film: 4.7K ohms ±5%, 1/8 w.
D1	19A700053P3	Silicon: 2 Diodes in Series, Common	R25	19B800607P271	Metal film: 270 ohms $\pm 5\%$, 1/8 w.
	10/11 000001 0	Cathode; sim to MBAV70L.	R26	19A700043P7	Resistor, Variable
D2	19A703595P12	Diode, OPTO ELE	R27	19A702931P169	Metal film: 511 ohms ±1%, 200 VDCW, 1/8 w.
			R28	19B800607P821	Metal film: 820 ohms \pm 5%, 1/8 w.
J1	19B801587P7	Connector, DIN: 96 male contacts, right angle mounting; sim to AMP 650887-1.	R29	19B800607P561	Metal film: 560 ohms \pm 5%, 1/8 w.
J2	19A116659P31	Connector, printed wiring: 9 contacts	R30	19B800607P101	Metal film: 100 ohms \pm 5%, 1/8 w.
		rated at 5 amps; sim to Molex 09-66-1091.	R31 and	19B800607P103	Metal film: 10K ohms \pm 5%, 1/8 w.
J3	19A115938P24	Connector, Receptacle	R32	108006078102	Motol film: 11/ opmo +5% 1/8 w
		INDUCTORS	R33 R34	19B800607P102 19B800607P471	Metal film: 1K ohms \pm 5%, 1/8 w. Metal film: 470 ohms \pm 5%, 1/8 w.
L1	19A705470P24	Coil, Fixed	R34 R35	19B800607P471 19B800607P181	Metal film: 180 ohms $\pm 5\%$, 1/8 w.
		———— TRANSISTORS ———	R35 R36	19B800607P181	Metal film: 27 ohms $\pm 5\%$, 1/8 w.
~	40470007000		R30 R37	19B800607P270	Metal film: 27 on $\pm 5\%$, 1/8 w.
Q1 thru Q3	19A700076P2	Silicon, NPN: sim to MMBT3904, low profile.	R38	19A702931P137	Metal film: 237 ohms ±1%, 200 VDCW, 1/8 w.
Q4 19A700059P2		Silicon, PNP: sim to MMBT3906, low profile.	R39	19A702931P221	Metal film: 1620 ohms ±1%, 200 VDCW, 1/8 w.
		RESISTORS	R40	19B800607P103	Metal film: 10K ohms ±5%, 1/8 w.
R1	19B800607P472	Metal film: 4.7K ohms ±5%, 1/8 w.	R41	19B800607P471	Metal film: 470 ohms ±5%, 1/8 w.
R2	19B800607P103	Metal film: 10K ohms \pm 5%, 1/8 w.	R42	19B800607P103	Metal film: 10K ohms ±5%, 1/8 w.
and R3					
R4	19B800607P563	Metal film: 56K ohms \pm 5%, 1/8 w.	S1	19A149955P2	Switch, RKR
R5	19B800607P103	Metal film: 10K ohms \pm 5%, 1/8 w.			—— INTEGRATED CIRCUITS —
R6	19B800607P101	Metal film: 100 ohms \pm 5%, 1/8 w.	U1	19A702705P3	Digital: 8-Channel Analog Multiplexe
R7	19A700043P7	Resistor, Variable			sim to 4051BM.
R8 and R9	19B800607P101	Metal film: 100 ohms ±5%, 1/8 w.	U2 thru U4	19A116297P7	Linear: Dual Op Amp; sim to MC4558CD.
R10	19A700043P7	Resistor, Variable	U5	19A705927P1	Silicon, bipolar: sim to Avantek
R11	19B800607P101	Metal film: 100 ohms ±5%, 1/8 w.			MSA-0611.
R12	19B800607P103	Metal film: 10K ohms \pm 5%, 1/8 w.	U6	19A701999P5	Voltage Regulator, LM317
R13	19B800607P153	Metal film: 15K ohms \pm 5%, 1/8 w.			CRYSTAL
R14	19B800607P562	Metal film: 5.6K ohms \pm 5%, 1/8 w.	Y1	19A130605G37	FM, Oscillator
R15 thru	19A702931P301	Metal film: 10K ohms ±1%, 200 VDCW, 1/8 w.			MISCELLANEOUS
R17			18	19C321660G5	FM, Oscillator
R18	19A702931P269	Metal film: 5110 ohms ±1%, 200 VDCW, 1/8 w.	20	19A129392P32	Form, FREQ
R19	19A702931P201	Metal film: 1000 ohms ±1%, 200 VDCW, 1/8 w.			
R20	19A702931P322	Metal film: 16.5K ohms \pm 1%, 200 VDCW, 1/8 w.			
R21	19A702931P210	Metal film: 1240 ohms ±1%, 200 VDCW, 1/8 w.			

		MISCELLANEOUS			——— CAPACITORS ———			DIODES
2	19D904549G1	Board, Data.	C1	19A702052P1	Ceramic: 220 pF 10%, 50 VDCW.	D1	19A700053P3	Silicon: 2 Diodes in Serie
3	19D904559P1	Chassis.	C2	19A702052P116	Ceramic: 0.015 µF 5%, 50VDCW.	Da	404700505040	Cathode; sim to MBAV70
4	19D902555P1	Handle.	C3	19A702052P110	Ceramic: 4700 pF 5%, 50 VDCW.	D2	19A703595P12	Diode, OPTO ELE
5	19A702381P508	Screw, thd. form: No. 3.5-0.6 x 8.	C4	19A702052P130	Ceramic: 0.022 μF ±5%, 50 VDCW.			————— JACKS
6	19B235310P1	Nameplate, Blank.	C5	19A702052P114	Ceramic: 0.01 µF 5%, 50 VDCW.	J1	19B801587P7	Connector, DIN: 96 male angle mounting; sim to A
7	19A702364P408	Machine screw: TORX Drive, M3.5 - 0.6 x 8.	C6	19A702052P105	Ceramic: 1000 pF 5%, 50 VDCW.	J2	19A116659P31	Connector, printed wiring
8	19A700032P6	Lockwasher, internal tooth: No.	C7	19A702052P110	Ceramic: 4700 pF 5%, 50 VDCW.	02		rated at 5 amps; sim to M
-		3.5MM.	C8	19A702052P114	Ceramic: 0.01 µF 5%, 50 VDCW.	10	404445000504	09-66-1091.
			C9	19A702052P105	Ceramic: 1000 pF 5%, 50 VDCW.	J3	19A115938P24	Connector, Receptacle
			C10	19A702052P3	Ceramic: 470 pF 10%, 50 VDCW.			INDUCTORS
			C11	19A705205P2	Tantalum: 1 μ F, 16 VDCW; sim to Sprague 293D.	L1	19A705470P24	Coil, Fixed
			C12	19A702052P3	Ceramic: 470 pF 10%, 50 VDCW.			— — — — TRANSISTOR
			C13 and C14	19A702052P14	Ceramic: 0.01 µF 10%, 50 VDCW.	Q1 thru Q3	19A700076P2	Silicon, NPN: sim to MMI profile.
			C15	19A702052P26	Ceramic: 0.1µF 10%, 50 VDCW	Q4	19A700059P2	Silicon, PNP: sim to MME
			C16	19A702052P14	Ceramic: 0.01 µF 10%, 50 VDCW.			profile.
			C17	19A702052P5	Ceramic: 1000 pF ±10%, 50 VDCW.			RESISTORS
			C18	19A702052P26	Ceramic: 0.1µF 10%, 50 VDCW	R1	19B800607P472	Metal film: 4.7K ohms ±5
			C19	19A702052P14	Ceramic: 0.01 µF 10%, 50 VDCW.	R2	19B800607P103	Metal film: 10K ohms ±5%
			C20	19A702052P1	Ceramic: 220 pF 10%, 50 VDCW.	and		
			C21	19A702236P43	Ceramic: 51 pF ±10%, 50 VDCW.	R3	400000070500	Matal films 50K along 150
			C22	19A702052P1	Ceramic: 220 pF 10%, 50 VDCW.	R4	19B800607P563	Metal film: 56K ohms ±59
			C23	19A702052P14	Ceramic: 0.01 µF 10%, 50 VDCW.	R5	19B800607P103	Metal film: 10K ohms ±5%
			thru C25			R6	19B800607P101	Metal film: 100 ohms ±5%
			C27	19A705205P2	Tantalum: 1 μF, 16 VDCW; sim to	R7 R8	19A700043P7 19B800607P101	Resistor, Variable Metal film: 100 ohms ±5%
			C28	19A705205P6	Sprague 293D. Tantalum: 10 μF, 16 VDCW; sim to	and R9	19800007 F 101	Metal IIII. 100 01115 ± 37
			020	19A703203F0	Sprague 293D.	R10	19A700043P7	Resistor, Variable
			C29	19A702052P5	Ceramic: 1000 pF ±10%, 50 VDCW.	R11	19B800607P101	Metal film: 100 ohms ±5%
			and C30			R12	19B800607P103	Metal film: 10K ohms ±5%
			C31	19A702052P26	Ceramic: 0.1µF 10%, 50 VDCW	R13	19B800607P153	Metal film: 15K ohms ±5%
			and C32			R14	19B800607P562	Metal film: 5.6K ohms ±5
			C33 and	19A702052P5	Ceramic: 1000 pF \pm 10%, 50 VDCW.	R15 thru R17	19A702931P301	Metal film: 10K ohms ±19 VDCW, 1/8 w.
			C34 C35	19A705205P2	Tantalum: 1 μF, 16 VDCW; sim to Sprague 293D.	R18	19A702931P269	Metal film: 5110 ohms ±1 VDCW, 1/8 w.
			C36	19A702052P5	Ceramic: 1000 pF ±10%, 50 VDCW.	R19	19A702931P201	Metal film: 1000 ohms ±1 VDCW, 1/8 w.
			C37	19A705205P2	Tantalum: 1 μ F, 16 VDCW; sim to Sprague 293D.	R20	19A702931P322	Metal film: 16.5K ohms ± VDCW, 1/8 w.
			C38 and C39	19A702052P5	Ceramic: 1000 pF ±10%, 50 VDCW.	R21	19A702931P210	Metal film: 1240 ohms ±1 VDCW, 1/8 w.
* COMPON		ED OR CHANGED BY PRODUCTION CHANGES	* COMP0		ED OR CHANGED BY PRODUCTION CHANGES			<u> </u>
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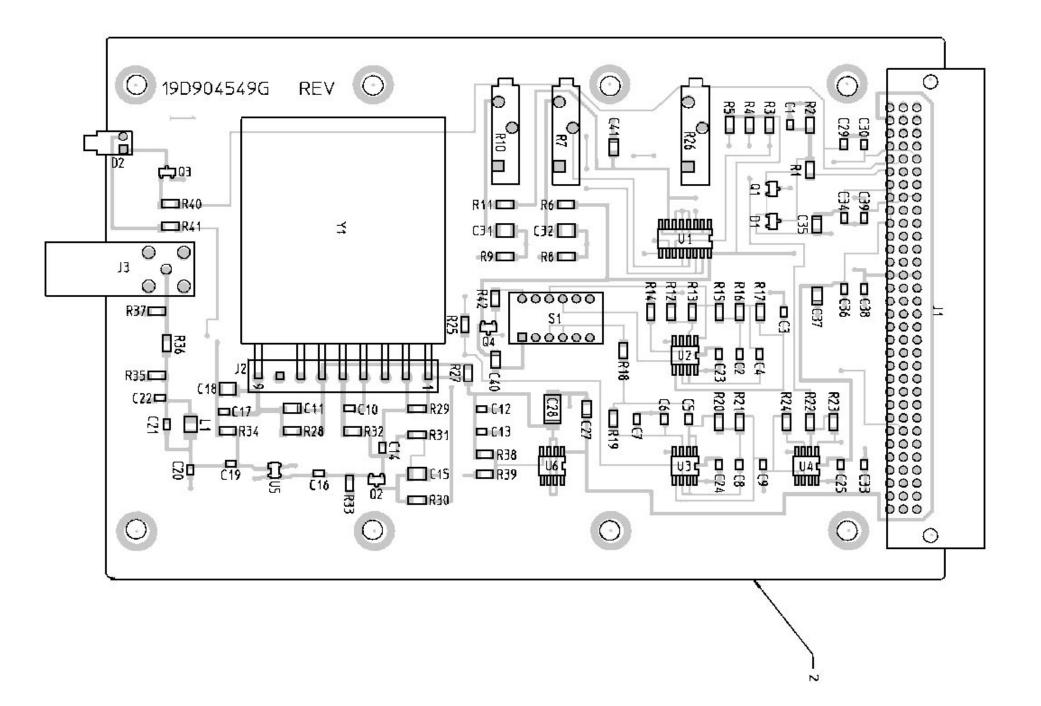


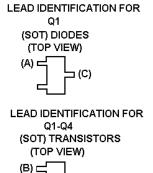
DATA MODULE 19D904558G1

(19D904558, Rev. 0)

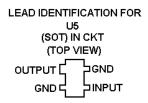
OUTLINE DIAGRAM







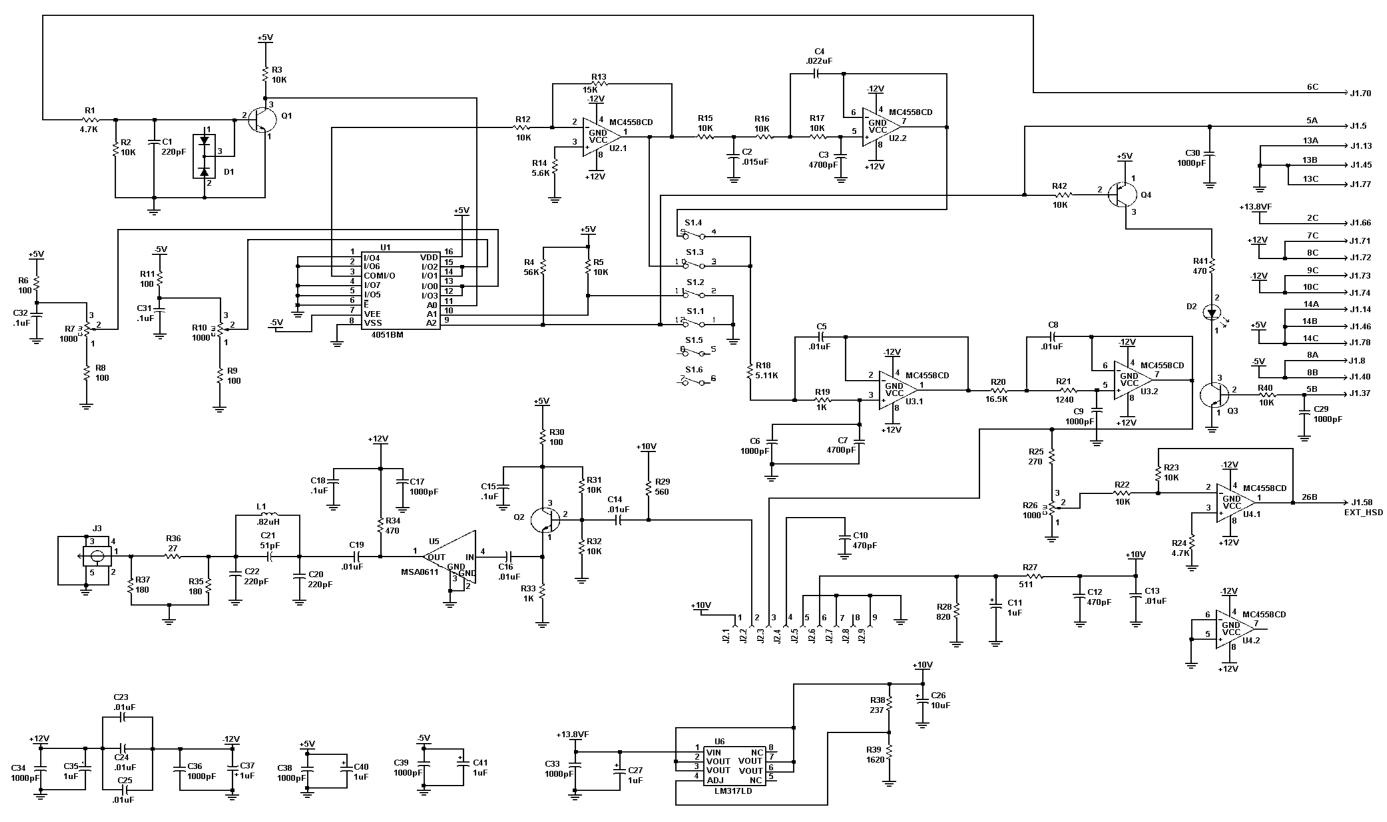
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UNIVERSAL DATA ADAPTER 19D904549G1

(19D904549, Rev. 1)



UNIVERSAL DATA ADAPTER 19D904549G1

(19D904556, Rev. 1)

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